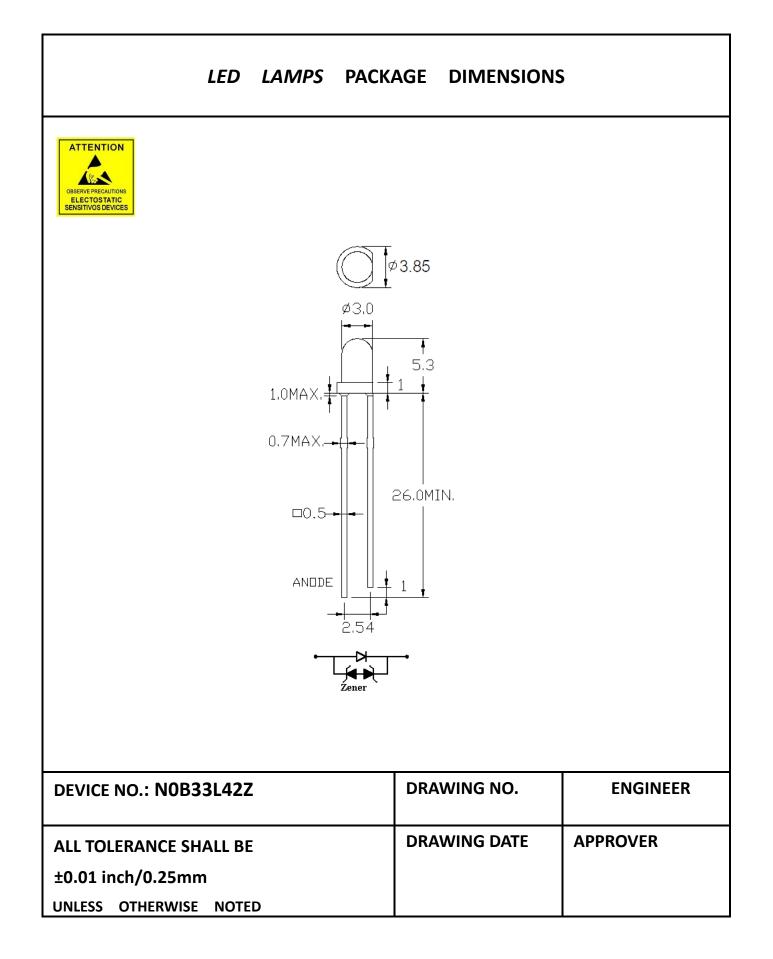


APPROVAL SHEET

CUSTOMER:					
TYPE NO.: <u>N0</u>	B33L42Z				
PACKAGE SIZE:	3.0mm Round Type	LED Lamp			
DICE MATERIAL:	InGaN	PEAK WAVE LEN	GTH(nm)	470	
EMITTED COLOR:	Super Blue		VIEWING ANGLE (deg):		
LENS COLOR:	Water Clear	IV(mcd):	5000		

ELECTRICAL / O	PTICAL CHA	RACTERISI	TICS AT	Ta = 25° C		
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNIT	TEST
Luminous Intensity	IV	3500	5000	7000	mcd	
Viewing Angle	201/2		30		deg	
Peak Emission Wavelength	λρ		470		nm	
Dominant Wavelength	λd	464	467	470	nm	IF = 20mA
Spectral Line Half-Width	Δλ		45		nm	
Forward Voltage	VF	2.8	3.1	3.5	V	
Power Dissipation	Pd			85	mW	
Peak Forward Current (Duty1/10 @ 1KHZ)	IF (Peak)			100	mA	
Recommended Operating Current	IF (Rec)		20		mA	
ABSOLUTE N	MAXIMUM	RATINGS	: (Ta =	25°c)		
Reverse Voltage			:	5 Volt		
Reverse Current			:	10 uA	(VR=5\	/)
Electrostatic Disc	harge (ESD)		:	2000 Volt		
Operating Tempe	erature Range	е	:	-40°C	TO 85	°C
Storage Temperature Range			:	-40°C	TO 100	°C
Lead Soldering Te 【1.6 mm (1/16 in	-	_	:	260°C For	r 5 Second	s



Typical Electro-Optical Characteristics Curves

Super Blue (InGaN $\lambda P=470nm$)

50 50 40 40 Forward Current IF(mA) Forward Current IF(mA) 30 30 20 20 10 10 0 2.8 3.2 3,4 3.6 2.6 3.0 20 40 80 100 60 Ambient Temperature Ta(℃) Forward Voltage(V) Forward Current Derating Curve Forward Current vs. Forward Voltage 2 **Relative Luminous Intensity** 1.2 **Relative Luminous Intensity** 1.0 1 0.8 0.6 0.5 0.4 0.2 0.2 0 20 30 10 0.1-20 0 1030 70 50 Forward current (mA) Ta=25°C Luminous Intensity vs. Forward current Ambient Temperature Ta= °C Luminous Intensity vs. Ambient Temperature Blue Green Yellow Orange Super Red Bright Red Blue Blue Green GaN InGaN InGaN GaP GaAsP/GaP GaAsP/GaP GaAlAs GaP Relative Radiant Intensity 0 2.0 500 400450 600 650 750 550 700 Wavelength 入(nm)

RELATIVE INTENSITY VS. WAVELENGTH

Reliability test For LED Lamps

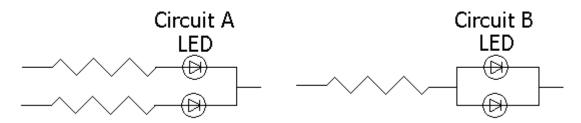
Type No. : N0B33L42Z

NO.	ltem	Test Conditions	Test Time/ Cycle	Sample Size	Ac/Re
1	DC Operating Life	Temperature:25°C IF:20mA	1000HRS	20PCS	0/1
2	High Temperature High Humidity	Temperature:85°C 85%RH	1000HRS	20PCS	0/1
3	High Temperature Storage	Temperature:100°C	1000HRS	20PCS	0/1
4	Low Temperature Storage	Temperature: — 40°C	1000HRS	20PCS	0/1
5	Temperature Cycling	85°C~ 25°C~ — 35°C 15min~ 5min~ 15min	15Cycles	20PCS	0/1
6	Thermal Shock	85°C~ 25°C~—10°C 5min~ 10sec ~ 5min	15Cycles	20PCS	0/1
7	Solder Heat	Temperature:260°C±5°C	10SEC.	20PCS	0/1

Precautions For Use LED

1. Drive Method

LED is current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in a application, it is recommended that a current limiting resistor be incorporated in the drive circuit.



- (a) Circuit A it is recommended circuit.
- (b) Circuit B the brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

2. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

3. Storage

The Storage Temperature and RH are: 5°C ~ 30°C, RH 60% or less. Once the package is opened, the products should be used with in a week. Otherwise, they should be kept in moisture proof package with moisture absorbent material (silica gel). we suggest our customers to use our products within a year. If the moisture absorbent material (silica gel) has faded away or the LEDs exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: more than 24 hours at 60°C ±5°C.

4. Electrostatic Discharge (ESD)

Static electricity or surge voltage will damage the LEDs Suggestions to prevent ESD damage:

Use of a conductive wrist band or ante-electrostatic glove when handing these LEDs

All devices, equipment, and machinery must be properly grounded.

Worktables storage racks, etc. should be properly grounded

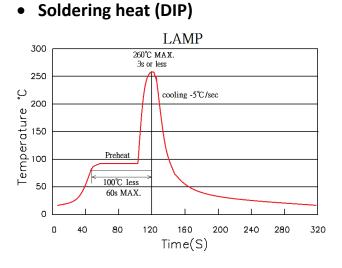
In the events of manual working in process, make sure the devices are well protected from ESD at any time.

5. Others

- (a) If want to have the uniform luminance and color, please use the same binning number, and avoid using intermix to cause the differences of luminance and color.
- (b) The appearance and specifications of the product may be modified for improvement without prior notice.

6. Soldering

Recommended soldering condition as shown below:



Soldering Iron

Temperature at tip of iron: 350°C Max. Soldering Time: 3 sec. ± 1 sec. (one time only) If temperature is higher, time should be shorter